

## Descriptions

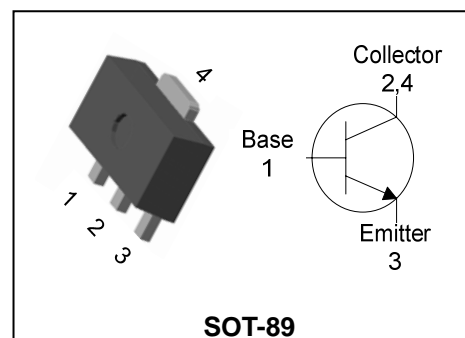
- Medium power amplifier

## Features

- $P_C$ (Collector power dissipation)=2W  
(Ceramic substrate of 250 mm<sup>2</sup>×0.8t used)
- Low collector saturation voltage :  
 $V_{CE(sat)}$ =0.5V(Typ.)
- Complementary pair with STB1188
- “Green” device and RoHS compliant device
- Available in full lead (Pb)-free device



## PIN Connection



## Ordering Information

Type NO.	Marking	Package Code
STD1766	B2 □YWW	SOT-89

B2: DEVICE CODE, □ :  $h_{FE}$  rank, YWW(Y : Year code, WW : Weekly code)

## Absolute maximum ratings

(Ta=25°C)

Characteristic	Symbol	Ratings	Unit
Collector-Base voltage	$V_{CBO}$	40	V
Collector-Emitter voltage	$V_{CEO}$	32	V
Emitter-Base voltage	$V_{EBO}$	5	V
Collector current	$I_C$	2	A(DC)
	$I_{CP}^*$	4	A(Pulse)
Collector power dissipation	$P_C$	0.5	W
	$P_C^{**}$	1	
Junction temperature	$T_J$	150	°C
Storage temperature	$T_{stg}$	-55 ~ 150	°C

Characteristic		Symbol	Typ.	Max	Unit
Thermal resistance	Junction-ambient	$R_{th(J-A)}$	-	250.0	°C/W
		$R_{th(J-A)}^{**}$	-	125.0	

\* : Single pulse,  $t_p=300 \mu s$

\*\* : When mounted on ceramic substrate(250 mm<sup>2</sup>×0.8t )

## Electrical Characteristics

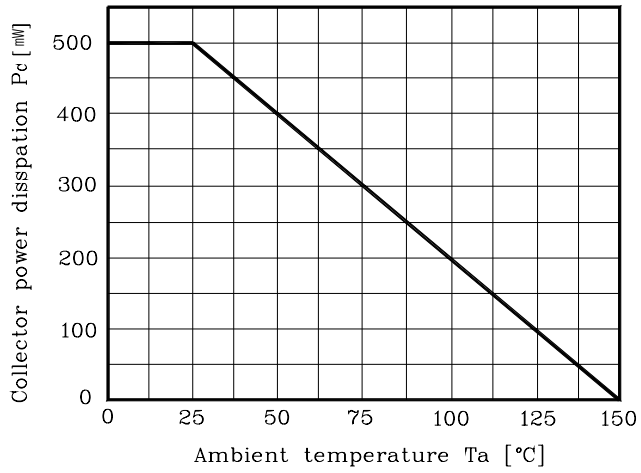
(Ta=25°C)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Collector-Base breakdown voltage	$BV_{CBO}$	$I_C=50\ \mu A, I_E=0$	40	-	-	V
Collector-Emitter breakdown voltage	$BV_{CEO}$	$I_C=1\ mA, I_B=0$	32	-	-	V
Emitter-Base breakdown voltage	$BV_{EBO}$	$I_E=50\ \mu A, I_C=0$	5	-	-	V
Collector cut-off current	$I_{CBO}$	$V_{CB}=20V, I_E=0$	-	-	1	$\mu A$
Emitter cut-off current	$I_{EBO}$	$V_{EB}=4V, I_C=0$	-	-	1	$\mu A$
DC current gain	$h_{FE}^*$	$V_{CE}=3V, I_C=0.5A$	100	-	320	-
Collector-Emitter saturation voltage	$V_{CE(sat)}$	$I_C=2A, I_B=200\ mA$	-	0.5	0.8	V
Transition frequency	$f_T$	$V_{CB}=5V, I_C=500\ mA$	-	100	-	MHz
Collector output capacitance	$C_{ob}$	$V_{CB}=10V, I_E=0, f=1\ MHz$	-	30	-	pF

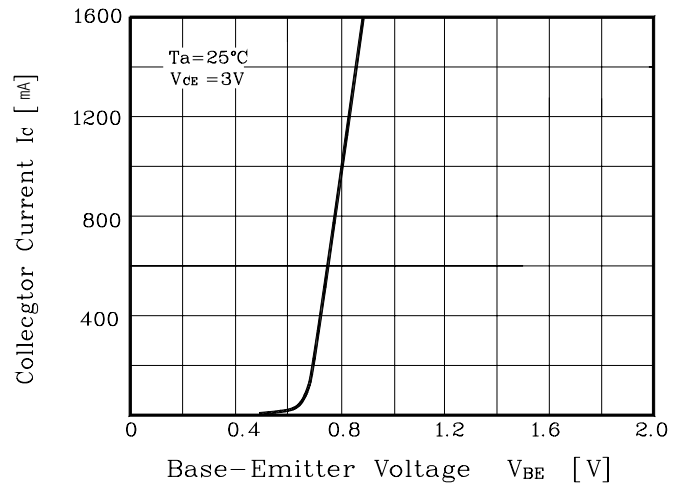
\* :  $h_{FE}$  rank / O : 100~200, Y : 160~320

## Electrical Characteristic Curves

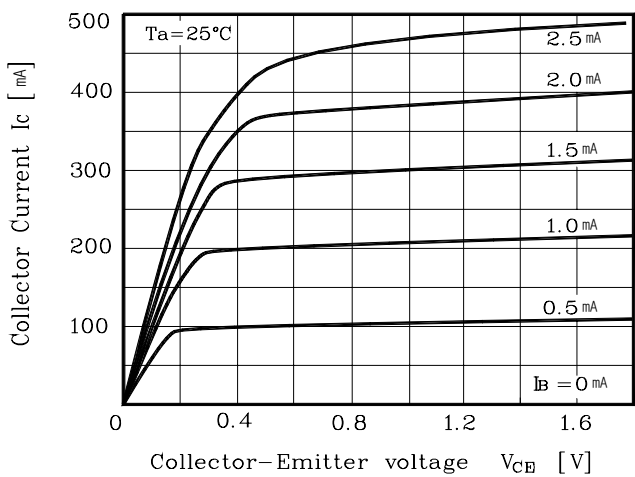
**Fig. 1  $P_C$  -  $T_a$**



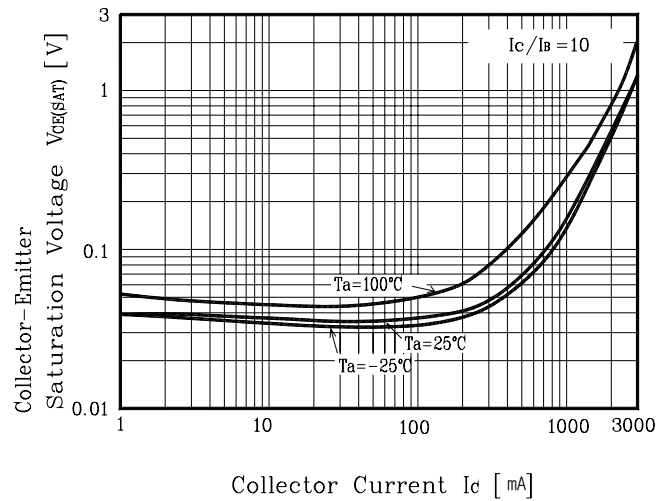
**Fig. 2  $I_C$  -  $V_{BE}$**



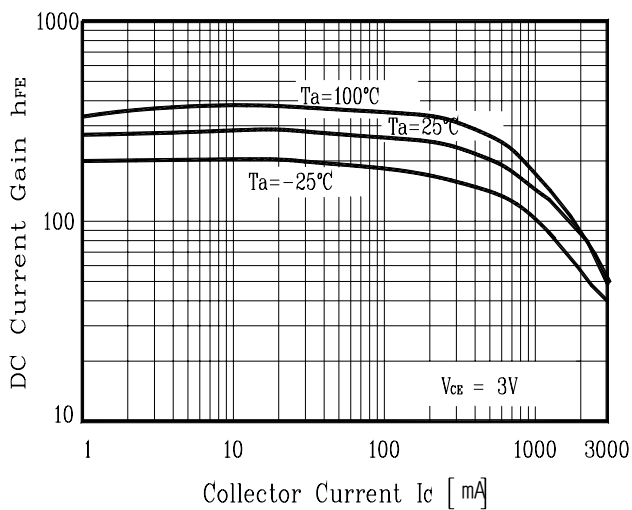
**Fig. 3  $I_C$  -  $V_{CE}$**



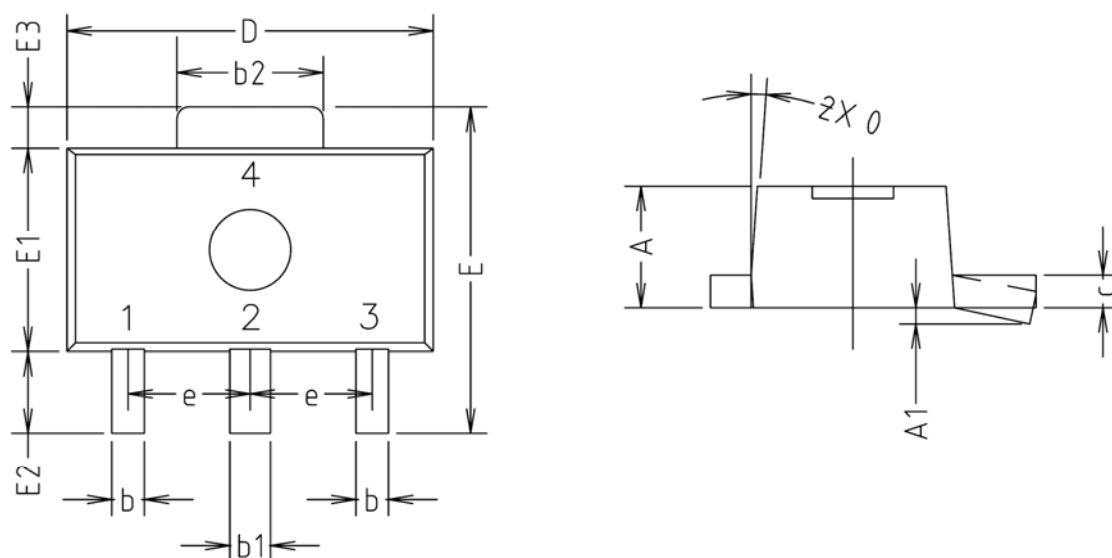
**Fig. 4  $V_{CE(sat)}$  -  $I_C$**



**Fig. 5  $h_{FE}$  -  $I_C$**

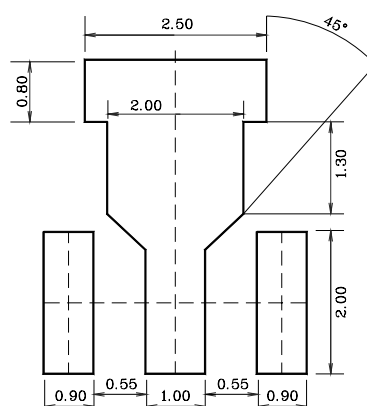


## Outline Dimension(mm)



SYMBOL	MILLIMETERS			NOTE
	MINIMUM	NOMINAL	MAXIMUM	
A	1.40	1.50	1.60	
A1	0.00	—	0.10	
b	0.38	0.42	0.48	
b1	0.48	0.52	0.58	
b2	1.79	1.82	1.87	
c	0.40	0.42	0.46	
D	4.40	4.50	4.70	
E	3.70	4.00	4.30	
E1	2.40	2.50	2.70	
E2	0.80	1.00	1.20	
E3	0.40	0.50	0.60	
e	1.50 TYP.			
θ	4° TYP.			

※Recommend PCB solder land [Unit: mm]



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